

RoHS

COMPLIANT

HALOGEN

FREE

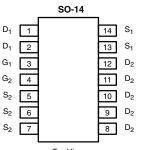
Vishay Siliconix

Dual N-Channel 20 V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY							
	V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
Channel-1	20	0.0085 at V _{GS} = 10 V	14.8	8.1			
		0.0115 at V _{GS} = 4.5 V	12.8	0.1			
Channel-2	20	0.0070 at V _{GS} = 10 V	22	8.4			
		0.0095 at V _{GS} = 4.5 V	18.9	0.4			

SCHOTTKY PRODUCT SUMMARY

V _{DS} (V)	V _{SD} (V) Diode Forward Voltage	I _F (A)
20	0.55 V at 2.5 A	2



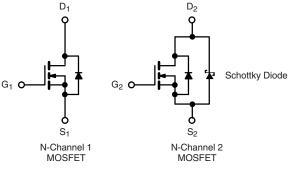
Top View

FEATURES

- Halogen-free According to IEC 61249-2-21 ٠ Definition
- TrenchFET[®] Power MOSFET
- 100 % Rg Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- DC/DC Converters, Synchronous Buck Converters
 - Game Stations -
 - Notebook PC Logic



Ordering Information: Si4340DDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Channel-1	nel-1 Channel-2			
Drain-Source Voltage	V _{DS}	2	V			
Gate-Source Voltage	V _{GS}	±	v			
	T _C = 25 °C		14.8	22		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C	L	11.8	17.6	•	
Continuous Drain Current (1) = 150°C)	T _A = 25 °C	- I _D	12.1 ^{b, c}	16.3 ^{b, c}		
	T _A = 70 °C		9.7 ^{b, c}	13 ^{b, c}		
Pulsed Drain Current (t = 300 μs)		I _{DM}	50	60	A	
Courses Ducia Coursent Diada Coursent	T _C = 25 °C	L.	2.5	4.5		
Source-Drain Current Diode Current	T _A = 25 °C	I _S	1.7 ^{b, c}	2.5 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	15			
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	11.25		mJ	
	T _C = 25 °C		3	5.4		
Movimum Dougs Discipation	T _C = 70 °C	D_	1.9	3.5	w	
Maximum Power Dissipation	T _A = 25 °C	PD	2 ^{b, c}	3 ^{b, c}	vv	
	T _A = 70 °C		1.3 ^{b, c}	1.9 ^{b, c}		
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150		°C		

THERMAL RESISTANCE RATINGS								
			Channel-1		Channel-2			
Parameter		Symbol	Тур.	Max.	Тур.	Max.	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	53	62.5	35	42	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	35	42	18	23	0/11	

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board. c. t = 10 s.

d. Maximum under steady state conditions for channel 1 is 110 °C/W and channel 2 is 87 °C/W.

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Parameter	Symbol	erwise noted) Test Conditions			Тур.	Max.	Unit
Static						1	1
	N/	$V_{GS} = 0 V, I_D = 250 \mu A$	Ch-1	20			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	Ch-2	20			V
V Tomporatura Coofficient		I _D = 250 μA	Ch-1		20		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 25 mA	Ch-2		22		
	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	Ch-1		- 4.4		mV/°C
V _{GS(th)} Temperature Coefficient		I _D = 25 mA	Ch-2		- 4.6		
O she Thursda she hi Malta an	N/	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	Ch-1	1		2.5	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	Ch-2	1		2.5	V
		$V_{DS} = 0 V, V_{GS} = \pm 20 V$	Ch-1			100	<u> </u>
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	Ch-2			100	nA
Zero Gate Voltage Drain Current		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-1			1	μA
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-2			100	
	IDSS	$V_{DS} = 20$ V, $V_{GS} = 0$ V, $T_{J} = 85$ °C	Ch-1			15	
		V_{DS} = 20 V, V_{GS} = 0 V, T_{J} = 85 °C	Ch-2			10 000	
	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	Ch-1	20			А
On-State Drain Current ^b		V _{DS} ≥ 5 V, V _{GS} = 10 V	Ch-2	30			
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 11.5 A	Ch-1		0.0065	0.0085	Ω
		V _{GS} = 10 V, I _D = 15.2 A	Ch-2		0.0060	0.0070	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	Ch-1		0.0091	0.0115	
	F	V _{GS} = 4.5 V, I _D = 14 A	Ch-2		0.0077	0.0095	
	9 _{fs}	V _{DS} = 10 V, I _D = 11.5 A	Ch-1		28		
Forward Transconductance ^b		V _{DS} = 10 V, I _D = 15.2 A	Ch-2		44		S
Dynamic ^a	<u> </u>		1		1	I	
			Ch-1		862		
Input Capacitance	C _{iss}	Channel-1	Ch-2		956		
Output Capacitance	C _{oss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	Ch-1		280		pF
Ouput Capacitance	O _{OSS}	Channel-2	Ch-2		363		
Reverse Transfer Capacitance	C _{rss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	Ch-1		116		
	133		Ch-2		120		
		$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$	Ch-1		17.4	26	
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$	Ch-2		17.8	27	nC
-	0	Channel-1	Ch-1		8.1	12.5	
		$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 12 \text{ A}$	Ch-2		8.4	12.5	
Gate-Source Charge	Q _{gs}		Ch-1		2.2		
	Q _{gd}	Channel-2	Ch-2 Ch-1		2.6 2.4		
Gate-Drain Charge		V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 12 A	Ch-2		2.4		-
			Ch-1		2.5	4.4	
Gate Resistance	R _g	f = 1 MHz	Ch-2		2.6	5.2	Ω

Notes:

a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.



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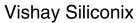
Parameter	Test Conditions	Min.	Тур.	Max.	Unit					
Dynamic ^a										
Turn-On Delay Time	t _{d(on)}	Observald	Ch-1		18	35				
	-d(0n)	Channel-1 V _{DD} = 10 V, R _I = 1 Ω	Ch-2		20	40				
Rise Time			Ch-1		37	70	4			
			Ch-2		34	65				
Turn-Off Delay Time	t _{d(off)}	Channel-2	Ch-1		19	35	-			
		$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 1 \Omega$	Ch-2 Ch-1		21 10	40 20				
Fall Time	t _f	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$			10	20	{			
			Ch-2 Ch-1		9	18	- ns			
Turn-On Delay Time	t _{d(on)}	Channel-1	Ch-2		9	18				
$\label{eq:VDD} \begin{array}{c} V_{DD} = 10 \text{ V}, \text{ R}_{L} = 1 \Omega \\ \text{Rise Time} & t_{r} & \text{I}_{D} \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{g} \end{array}$		V_{DD} = 10 V, R_L = 1 Ω	Ch-1		13	26				
	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	Ch-2		13	26	-				
Ture Off Delay Time	v Time t v m Channel-2	Ch-1		16	32					
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 10 \text{ V}, \text{ R}_{\text{I}} = 1 \Omega$	Ch-2		15	30	-			
Fall Time	t _f	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	Ch-1		8	16				
			Ch-2		8	16				
Drain-Source Body Diode Characteristic	s	1		1	T	1				
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C	Ch-1			2.5	A			
			Ch-2			4.5				
Pulse Diode Forward Current ^a	I _{SM}		Ch-1			50				
		I _S = 5 A	Ch-2		0.70	60				
Body Diode Voltage	V _{SD}	ŭ	Ch-1		0.76	1.2	v			
		I _S = 2.5 A	Ch-2		0.43	0.55				
Body Diode Reverse Recovery Time	t _{rr} Q _{rr}		Ch-1		18	36	ns			
		Channel-1	Ch-2		18 7	36				
Body Diode Reverse Recovery Charge		$I_F = 9.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$	Ch-1 Ch-2		7	14 14	nC			
			Ch-2 Ch-1		8	14				
Reverse Recovery Fall Time	t _a	Channel-2 I _F = 2.5 A, dl/dt = 100 A/μs, T _J = 25 °C	Ch-2		10					
	t _b	$F = 2.5 \text{ A}, \text{ al/at} = 100 \text{ A/} \mu \text{s}, \text{ I}_{\text{J}} = 25 \text{ °C}$	Ch-1		9		ns			
Reverse Recovery Rise Time			Ch-2		9					

Notes:

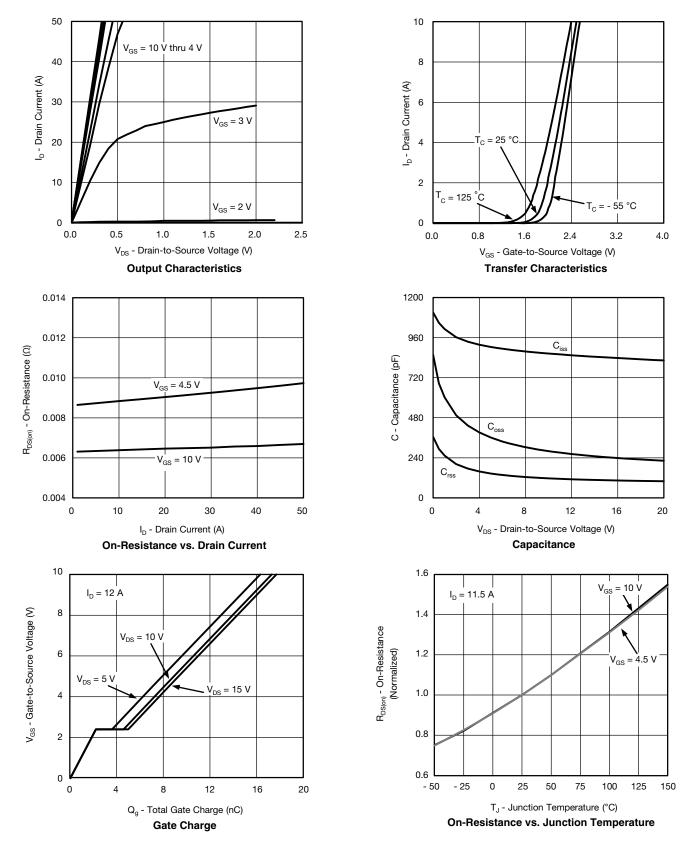
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.







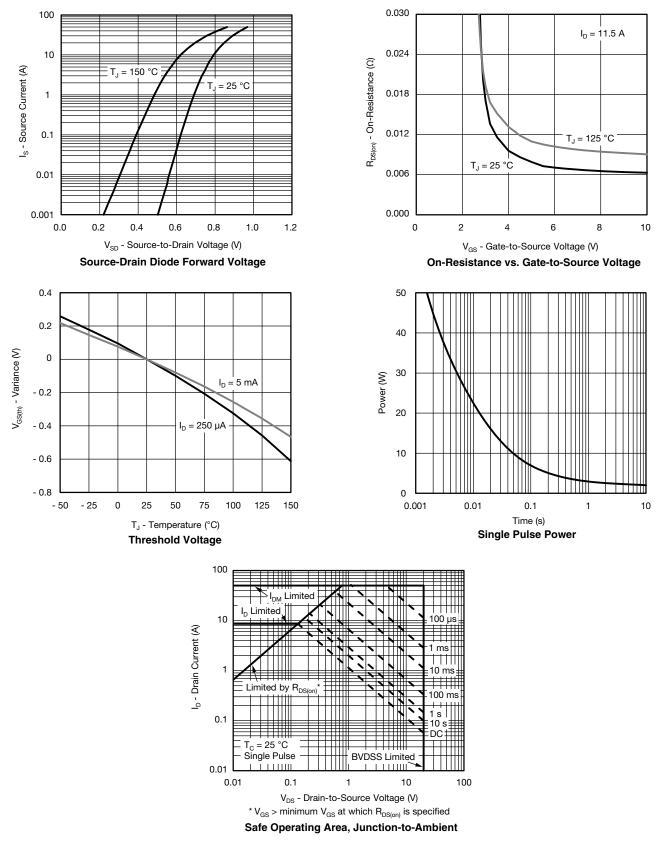
Document Number: 67583 S11-0860-Rev. A, 02-Mar-11

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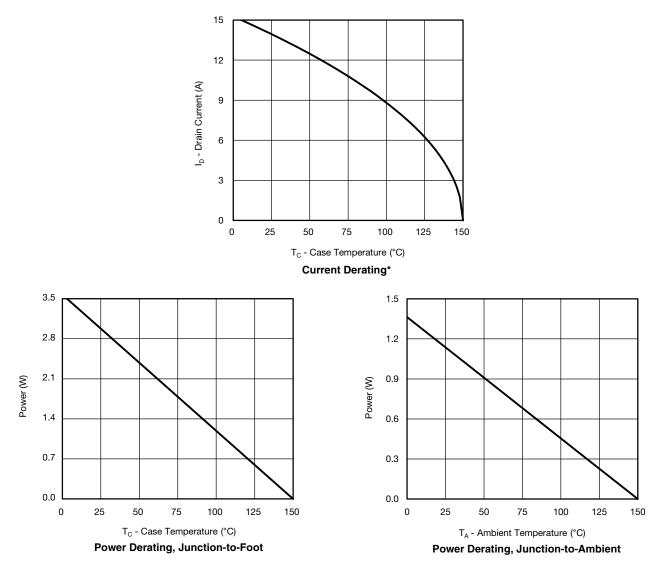
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CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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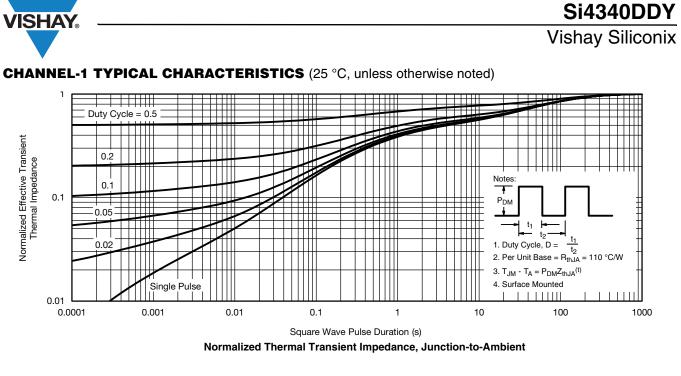


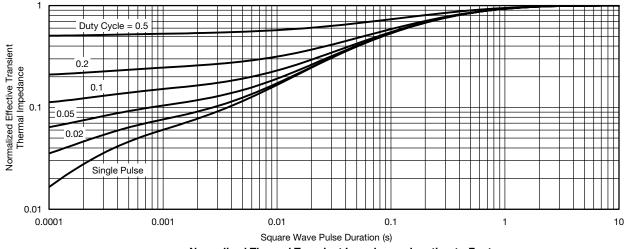
* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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6

Document Number: 67583 S11-0860-Rev. A, 02-Mar-11

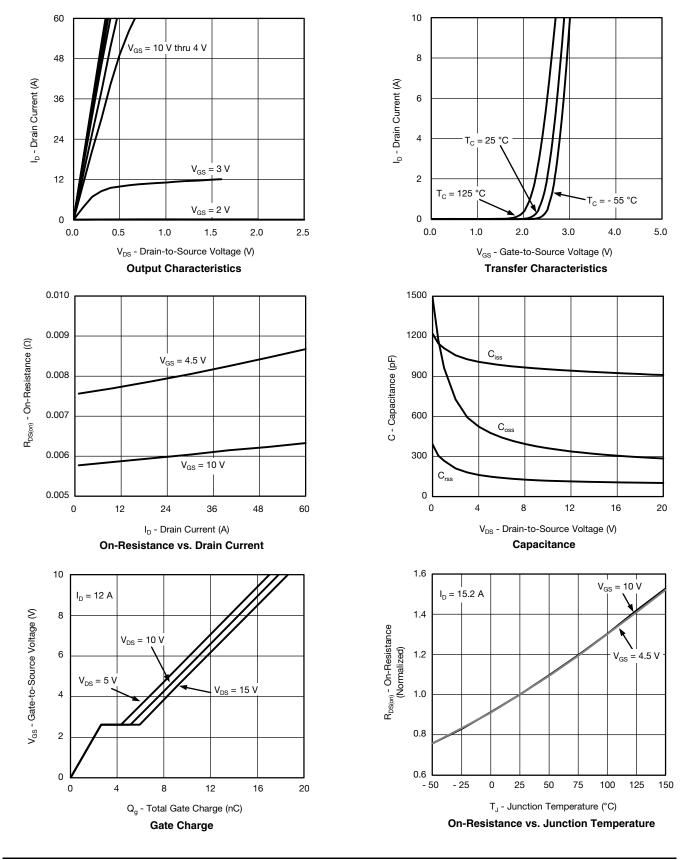




Normalized Thermal Transient Impedance, Junction-to-Foot







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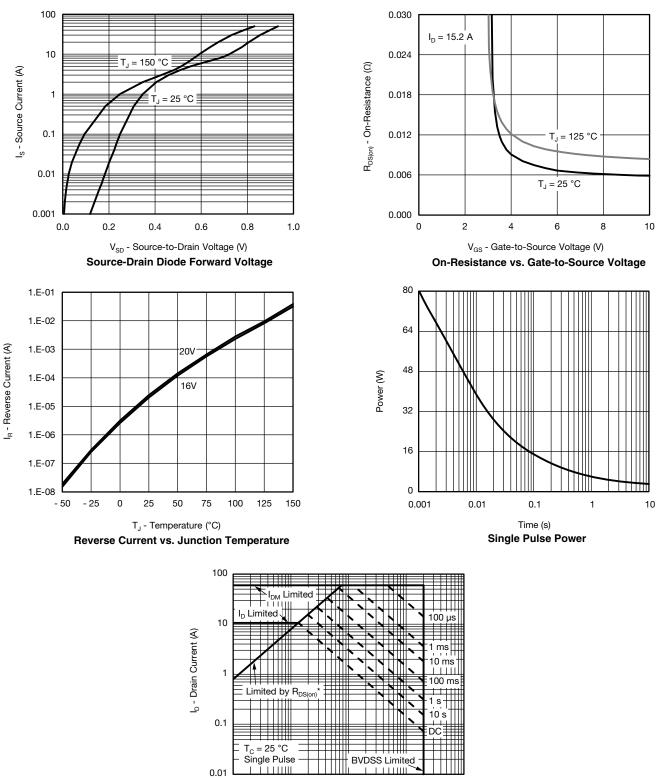
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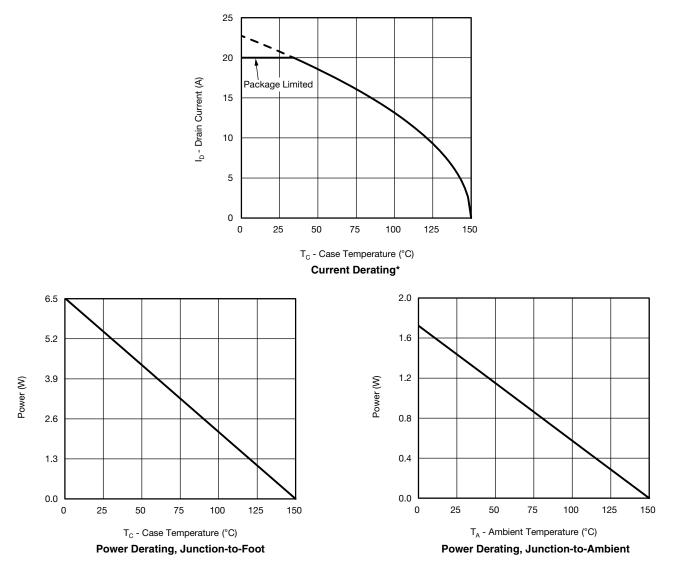
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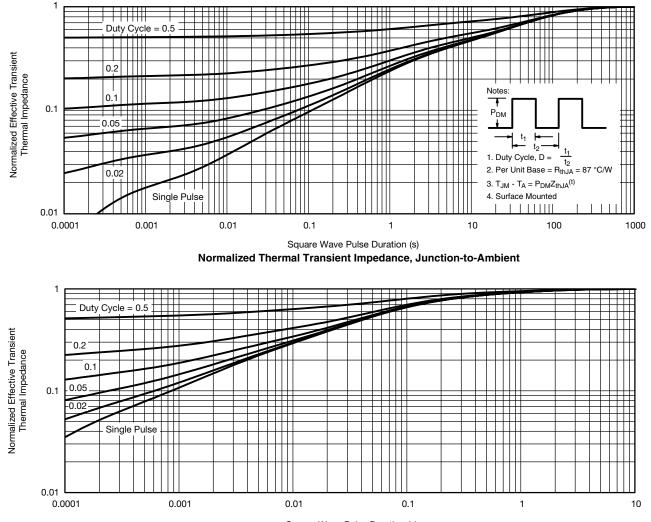




* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

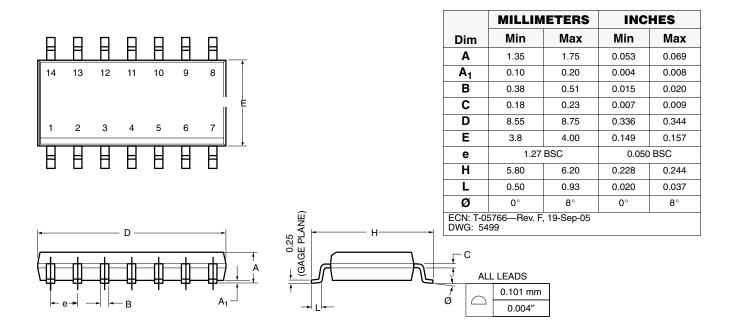
Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Foot

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Package Information Vishay Siliconix

SOIC (NARROW): 14-LEAD





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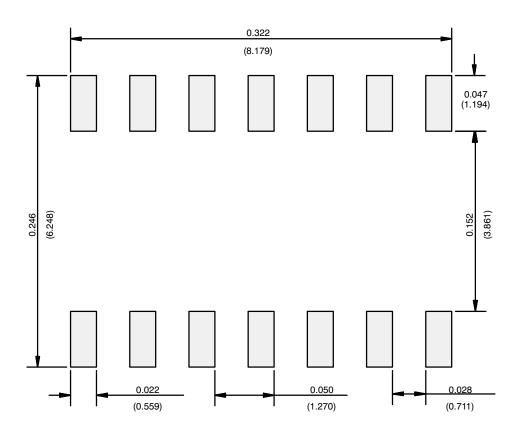
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Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-14



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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